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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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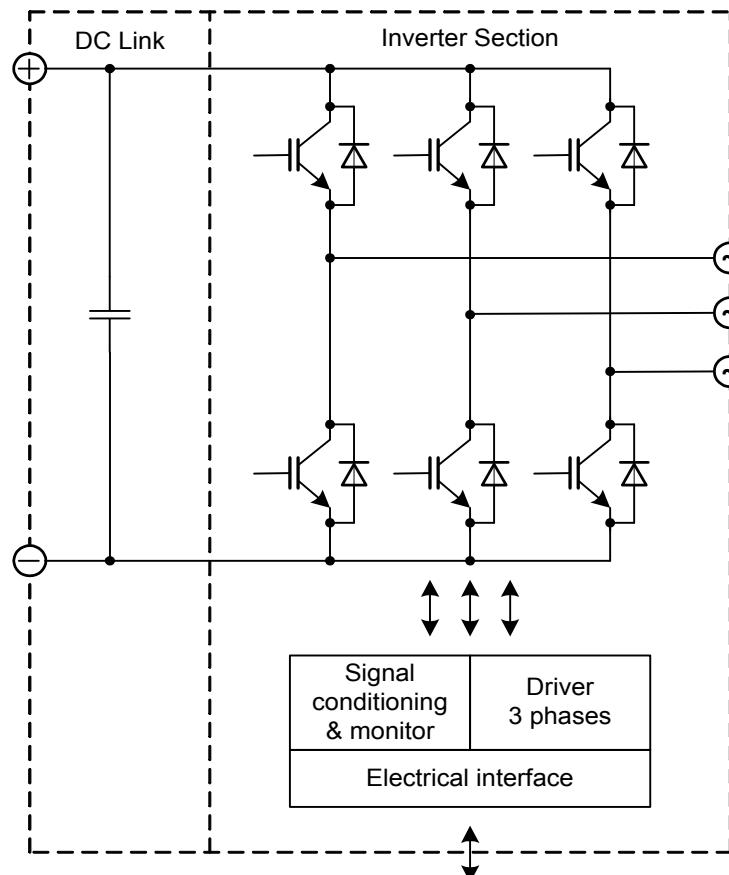
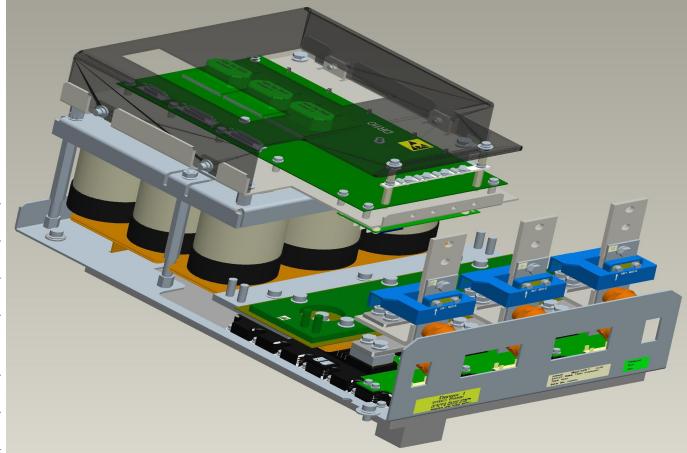
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

## General information

**IGBT Stack for typical voltages of up to 690 V<sub>RMS</sub>**  
**Rated output current 600 A<sub>RMS</sub>**

- High power converter
- Wind power
- Motor drives
- PrimePACK™3 module with integrated NTC
- Extended operational temperature
- Low  $V_{cesat}$

Topology	B6I
Application	Inverter
Load type	Resistive, inductive
Semiconductor (Inverter Section)	3x FF1000R17IE4
DC Link	3.6 mF
Heatsink	Water cooled
Implemented sensors	Current, voltage, temperature
Driver signals IGBT	Electrical
Sales - name	6MS10017E41W36460
SP - No.	SP000939300



# Technical Information

ModSTACK™

**6MS10017E41W36460**



**Preliminary data**

## Absolute maximum rated values

Collector-emitter voltage	IGBT; $T_{vj} = 25^\circ\text{C}$	$V_{CES}$	1700	V
Repetitive peak reverse voltage	Diode; $T_{vj} = 25^\circ\text{C}$	$V_{RRM}$	1700	V
DC link voltage		$V_{DC}$	1250	V
Insulation management	according to installation height of 2000 m	$V_{line}$	690	$V_{RMS}$
Insulation test voltage	according to EN 50178, $f = 50 \text{ Hz}$ , $t = 1 \text{ s}$	$V_{ISOL}$	2.5	$\text{kV}_{RMS}$
Repetitive peak collector current inverter section (IGBT)	$t_p = 1 \text{ ms}$	$I_{CRM2}$	1250	A
Repetitive peak forward current inverter section (Diode)	$t_p = 1 \text{ ms}$	$I_{FRM2}$	1250	A
$I^2t$ -value inverter section (Diode)		$I^2t$	140	$\text{kA}^2\text{s}$
Continuous current inverter section		$I_{AC2}$	710	$A_{RMS}$
Junction temperature	under switching conditions	$T_{vjop}$	150	$^\circ\text{C}$
Switching frequency inverter section		$f_{sw2}$	5	kHz

### Notes

Further maximum ratings are specified in the following dedicated sections

## Characteristic values

### DC Link

			min.	typ.	max.
Rated voltage		$V_{DC}$	1100	1250	V
Over voltage shutdown	within 150 $\mu\text{s}$			1250	V
Capacitor	1 s, 9 p, rated tol. +/- 10 %	$C_{DC}$	3.6		mF
		type	Foil		
Maximum ripple current	per device, $T_{amb} = 55^\circ\text{C}$	$I_{ripple}$		49	$A_{RMS}$
Balance or discharge resistor	per DC link unit	$R_b$	47		$k\Omega$

### Notes

Operation above 1100 V subject to reduced operating time according to EN 61071

### Inverter Section

			min.	typ.	max.
Rated continuous current	$V_{DC} = 1100 \text{ V}$ , $V_{AC} = 690 \text{ V}_{RMS}$ , $\cos(\phi) = 0.85$ , $f_{AC \text{ sine}} = 50 \text{ Hz}$ , $f_{sw} = 3000 \text{ Hz}$ , $T_{inlet} = 40^\circ\text{C}$ , $T_j \leq 150^\circ\text{C}$	$I_{AC}$			600 $A_{RMS}$
Continuous current at low frequency	$V_{DC} = 1100 \text{ V}$ , $V_{AC} = 690 \text{ V}_{RMS}$ , $f_{AC \text{ sine}} = 0 \text{ Hz}$ , $f_{sw} = 3000 \text{ Hz}$ , $T_{inlet} = 40^\circ\text{C}$ , $T_j \leq 150^\circ\text{C}$	$I_{AC \text{ low}}$			295 $A_{RMS}$
Rated continuous current for 150% overload capability	$I_{AC \text{ 150\%}} = 610 \text{ A}_{RMS}$ , $t_{on \text{ over}} = 60 \text{ s}$ , $T_j \leq 150^\circ\text{C}$	$I_{AC \text{ over1}}$			405 $A_{RMS}$
Rated continuous current for 150% overload capability	$I_{AC \text{ 150\%}} = 670 \text{ A}_{RMS}$ , $t_{on \text{ over}} = 3 \text{ s}$ , $T_j \leq 150^\circ\text{C}$	$I_{AC \text{ over2}}$			445 $A_{RMS}$
Over current shutdown	within 15 $\mu\text{s}$	$I_{AC \text{ OC}}$	1250		$A_{peak}$
Power losses	$I_{AC} = 600 \text{ A}$ , $V_{DC} = 1100 \text{ V}$ , $V_{AC} = 690 \text{ V}_{RMS}$ , $\cos(\phi) = 0.85$ , $f_{AC \text{ sine}} = 50 \text{ Hz}$ , $f_{sw} = 3000 \text{ Hz}$ , $T_{inlet} = 40^\circ\text{C}$ , $T_j \leq 150^\circ\text{C}$	$P_{loss}$	9800		W

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## Preliminary data

### Controller interface

Driver and interface board	ref. to separate Application Note	DR110				
		min.	typ.	max.	V	
Auxiliary voltage		$V_{aux}$	18	24	30	
Auxiliary power requirement	$V_{aux} = 24\text{ V}$	$P_{aux}$		40		W
Digital input level	resistor to GND $1.8\text{ k}\Omega$ , capacitor to GND $4\text{ nF}$ , logic high = on, min. $15\text{ mA}$	$V_{in\ low}$	0		4	V
		$V_{in\ high}$	11		15	V
Digital output level	open collector, logic low = no fault, max. $15\text{ mA}$	$V_{out\ low}$	0		1.5	V
		$V_{out\ high}$		15		V
Analog current sensor output inverter section	load max $1\text{ mA}$ , @ $600\text{ A}_{RMS}$	$V_{IU\ ana2}$ $V_{IV\ ana2}$ $V_{IW\ ana2}$	3.4	3.5	3.6	V
Analog DC link voltage sensor output	load max $1\text{ mA}$ , @ $1100\text{ V}$	$V_{DC\ ana}$	7.7	7.9	8..1	V
Analog temperature sensor output inverter section (NTC)	load max $1\text{ mA}$ , @ $T_{NTC} = 72\text{ }^{\circ}\text{C}$ , corresponds to $T_j = 148\text{ }^{\circ}\text{C}$ at rated conditions	$V_{Theta\ NTC2}$		8.4		V
Analog temperature sensor output inverter section (Simulated)	load max $1\text{ mA}$ , @ $T_{NTC} = 72\text{ }^{\circ}\text{C}$ , corresponds to $T_j = 148\text{ }^{\circ}\text{C}$ at rated conditions	$V_{Theta\ sim2}$		9		V
Over temperature shutdown inverter section		$V_{Error\ OT2}$		9.3		V

### System data

			min.	typ.	max.
EMC robustness	according to IEC 61800-3 at named interfaces	power	$V_{Burst}$	2	kV
		control	$V_{Burst}$	1	kV
		aux (24V)	$V_{surge}$	1	kV
Storage temperature		$T_{stor}$	-40		$80\text{ }^{\circ}\text{C}$
Operational ambient temperature	PCB, DC link capacitor, bus bar, excluding cooling medium	$T_{op\ amb}$	-25		$55\text{ }^{\circ}\text{C}$
Cooling air velocity	PCB, DC link capacitor, bus bar, standard atmosphere	$V_{air}$	2		m/s
Humidity	no condensation	Rel. F	0		95 %
Vibration	according to IEC 60721			5	$\text{m/s}^2$
Shock	according to IEC 60721			40	$\text{m/s}^2$
Protection degree				IP00	
Pollution degree				2	
Dimensions	width x depth x height		590	338	366 mm
Weight				65	kg

### Heatsink water cooled

			min.	typ.	max.
Water flow	according to coolant specification from Infineon	$\Delta V/\Delta t$	15		$\text{dm}^3/\text{min}$
Water pressure				8	bar
Water pressure drop	at $15\text{ dm}^3/\text{min}$ water flow	$\Delta p$		200	mbar
Coolant inlet temperature		$T_{inlet}$	-40		$55\text{ }^{\circ}\text{C}$
Thermal resistance heatsink to ambient	per switch	$R_{th,ha}$		0.038	K/W
Cooling channel material				Copper	

### Notes

Composition of coolant: Water and 52 vol. % Antifrogen N

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## Preliminary data

### Overview of optional components

	Unit 1	Inverter Section	Unit 3
Parallel interface board			
Optical interface board			
Voltage sensor		x	
Current sensor		x	
Temperature sensor		x	
Temperature simulation		x	
DC link capacitors		x	
Collector-emitter Active Clamping		x	

#### Notes

Setting of Active Clamping TVS-Diodes:  $V_Z = 1280\text{ V}$

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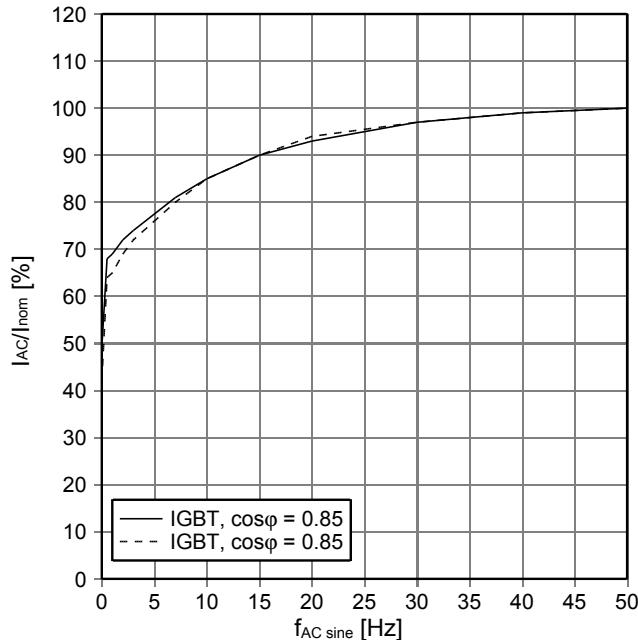
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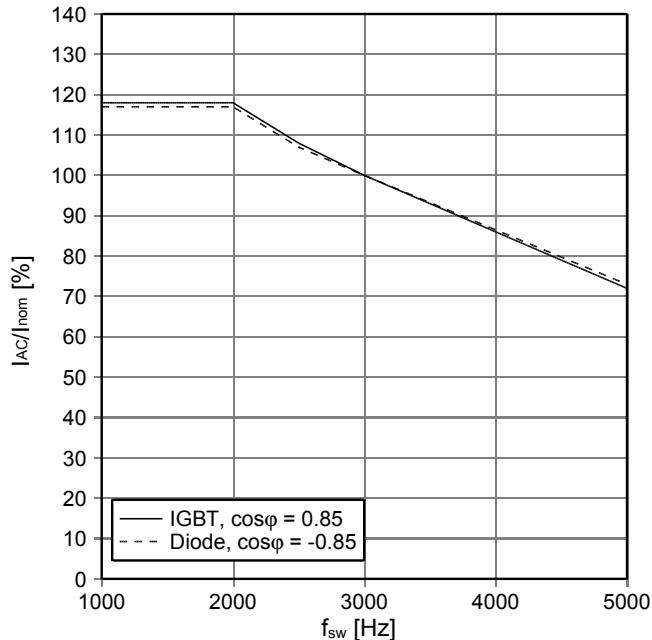


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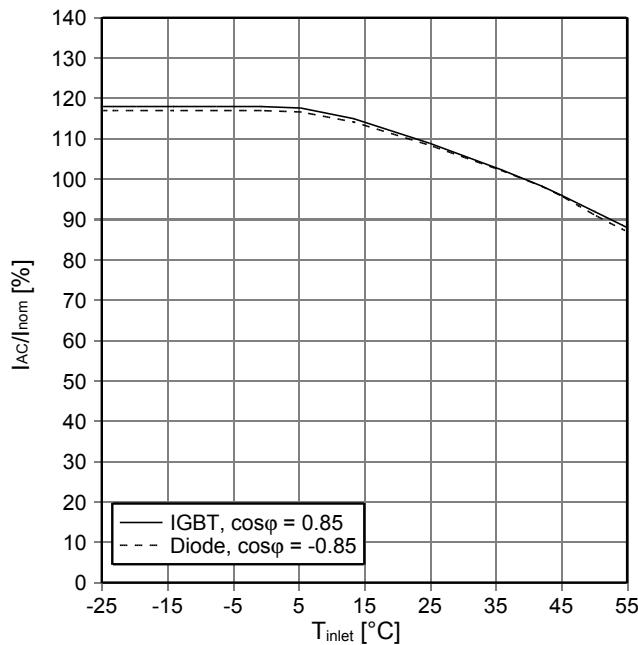
$f_{AC\ sine}$  - derating curve IGBT (motor), Diode (generator)  
 $V_{DC} = 1100\text{ V}$ ,  $V_{AC} = 690\text{ V}_{RMS}$ ,  $f_{sw} = 3\text{ kHz}$ ,  $\cos\phi = \pm 0.85$   
 $T_{inlet} = 40^\circ\text{C}$  and nom. cooling conditions



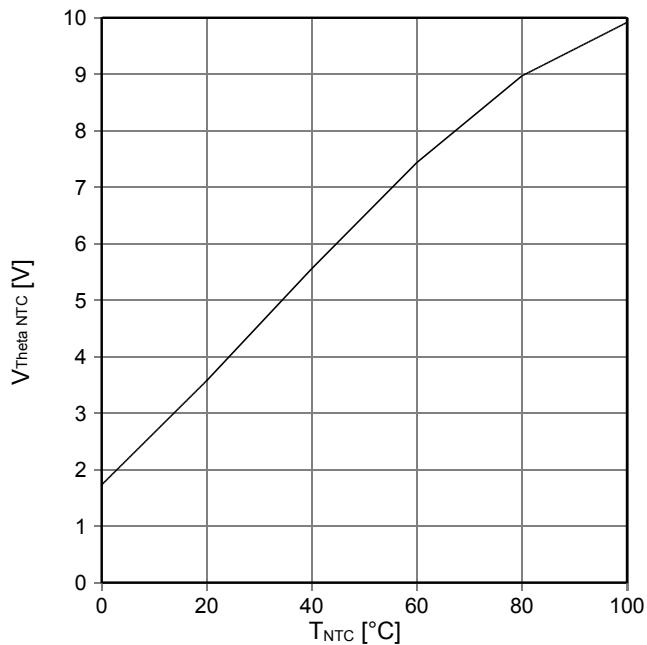
$f_{sw}$  - derating curve IGBT (motor), Diode (generator)  
 $V_{DC} = 1100\text{ V}$ ,  $V_{AC} = 690\text{ V}_{RMS}$ ,  $f_{AC\ sine} = 50\text{ Hz}$ ,  $\cos\phi = \pm 0.85$   
 $T_{inlet} = 40^\circ\text{C}$  and nom. cooling conditions



$T_{inlet}$  - derating curve IGBT (motor), Diode (generator)  
 $V_{DC} = 1100\text{ V}$ ,  $V_{AC} = 690\text{ V}_{RMS}$ ,  $f_{AC\ sine} = 3\text{ kHz}$ ,  $f_{AC\ sine} = 50\text{ Hz}$   
 $\cos\phi = \pm 0.85$  and nom. cooling conditions



Analog temperature sensor output  $V_{\Theta_{NTC}}$   
Sensing NTC of IGBT module



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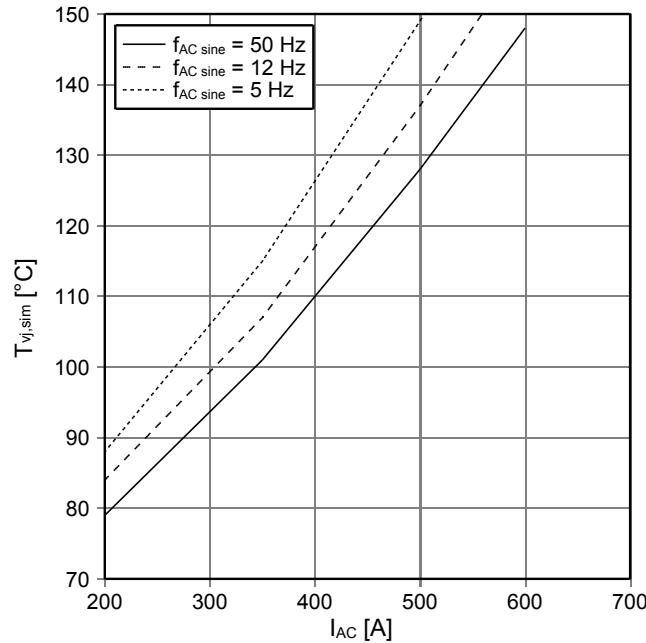
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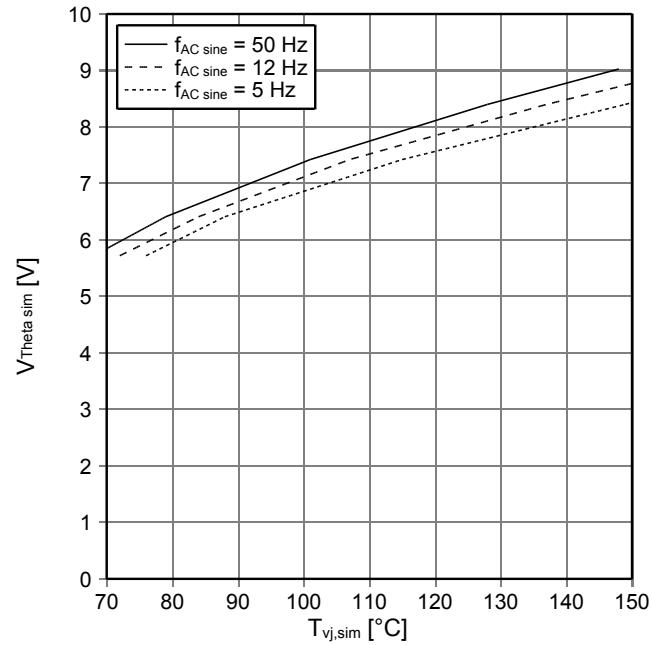


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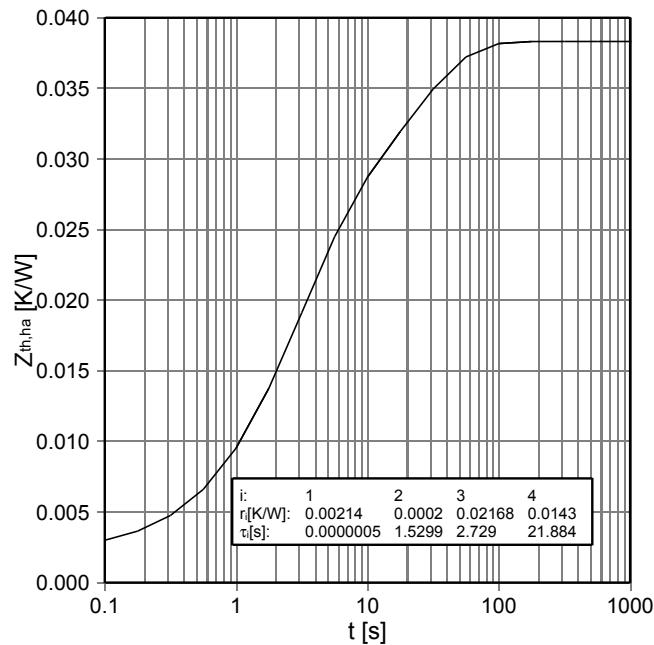
$T_{vj,sim}$  vs.  $I_{AC}$  - Simulated junction temperature  
 $V_{DC} = 1100$  V,  $V_{AC} = 690$  VRMS,  $f_{sw} = 3$  kHz  
 $T_{inlet} = 40^\circ\text{C}$  and nom. cooling conditions



Analog temperature sensor output  $V_{Theta\ sim}$   
 $V_{DC} = 1100$  V,  $V_{AC} = 690$  VRMS,  $f_{sw} = 3$  kHz,  
 $T_{inlet} = 40^\circ\text{C}$  and nom. cooling conditions



$Z_{th,ha}$  - thermal impedance heatsink to ambient per switch  
nom. cooling conditions



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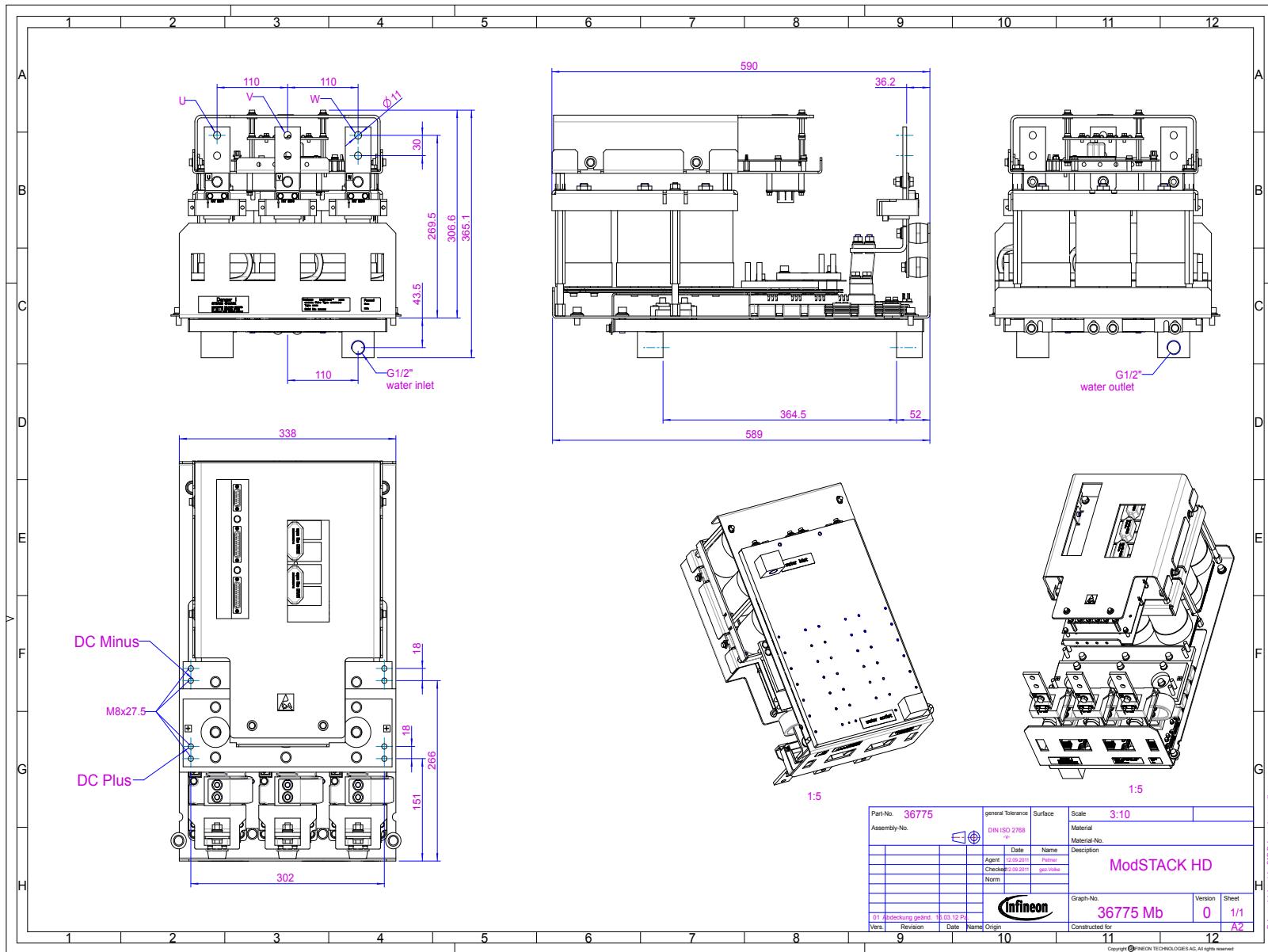
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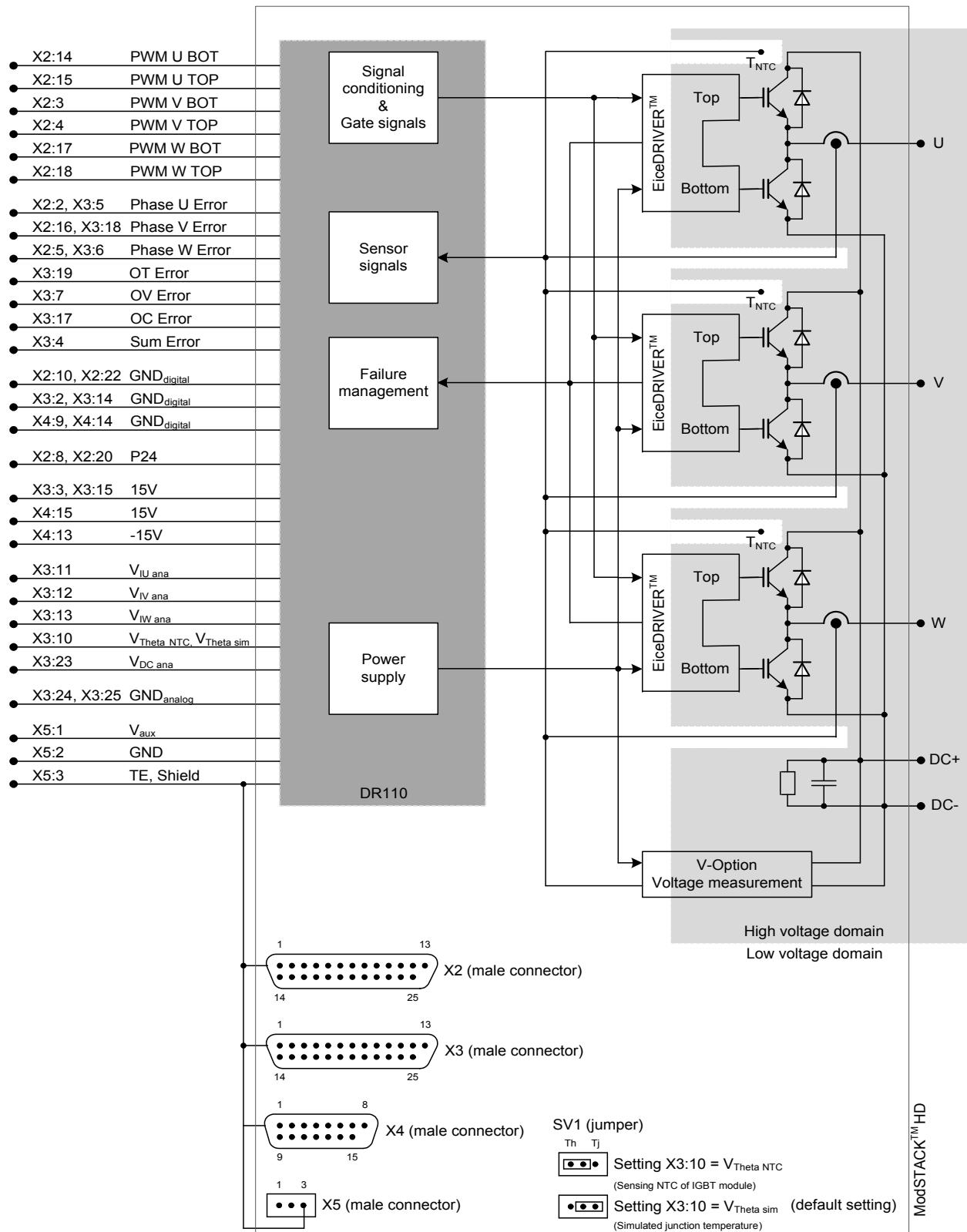


### Mechanical drawing



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## Circuit diagram



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Prior to installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced. To installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced.

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